



# NOT RECOMMENDED FOR NEW DESIGN, USE DMN3404L

**DMN3050S** 

#### N-CHANNEL ENHANCEMENT MODE MOSFET

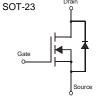
#### **Features**

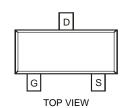
- Low On-Resistance: 35mΩ @ V<sub>GS</sub> = 10V 50mΩ @ V<sub>GS</sub> = 4.5V
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 2)
- "Green" Device (Note 3)
- Qualified to AEC-Q 101 Standards for High Reliability

## Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Copper leadframe.
  Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)







TOP VIEW

**Equivalent Circuit** 

### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Drain Source Voltage		$V_{DSS}$	30	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Drain Current (Note 1)	$T_A = 25$ °C $T_A = 70$ °C	I <sub>D</sub>	5.2 4.2	А
Drain Current (Note 1)	Pulsed	I <sub>DM</sub>	20	А
Body-Diode Continuous Current (Note 1)		Is	2.0	Α

#### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	$P_D$	1.4	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = 25°C (Note 1)	$R_{ hetaJA}$	90	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

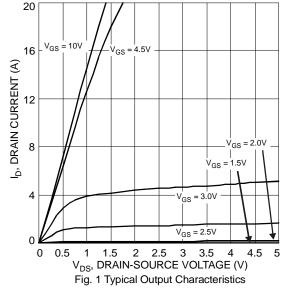
#### Electrical Characteristics @TA = 25°C unless otherwise specified

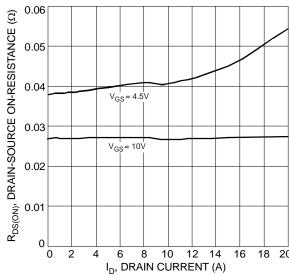
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V$ , $I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Body Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 4)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	1	1.5	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>	_	27	35	mΩ	$V_{GS} = 10V, I_D = 5.2A$
Static Brain Source on resistance	INDS (ON)		40	50		$V_{GS} = 4.5V, I_D = 4.2A$
Forward Transconductance	9fs	_	6.5	_	S	$V_{DS} = 5V$ , $I_{D} = 5.2A$
Source-Drain Diode Forward Voltage	$V_{SD}$	_	0.7	1	V	$V_{GS} = 0V, I_{S} = 1.0A$
DYNAMIC CHARACTERISTICS						
Input Capacitance	Ciss	_	390	_	pF	15)()(
Output Capacitance	Coss		55	_	pF	$V_{DS} = 15V, V_{GS} = 0V$ -f = 1.0MHz
Reverse Transfer Capacitance	$C_{rss}$	_	45	_	pF	71 - 1.0IVII IZ

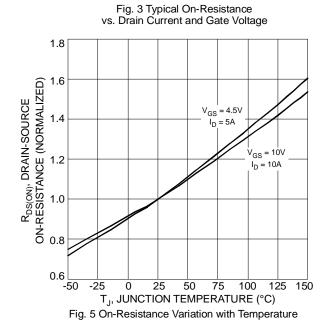
Notes:

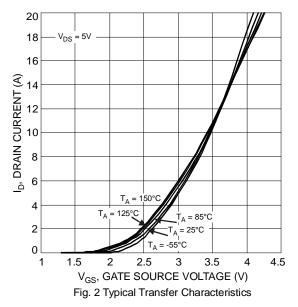
- 1. Device mounted on FR-4 PCB. t ≤5 sec.
- No purposefully added lead.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- 4. Short duration pulse test used to minimize self-heating effect.











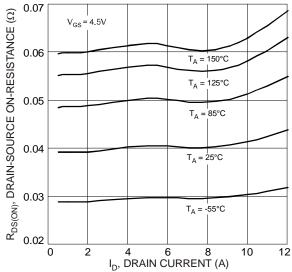
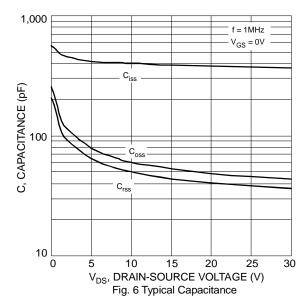
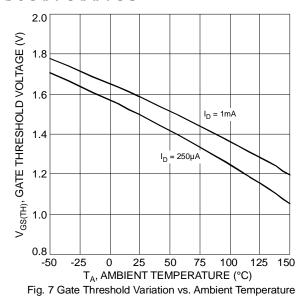


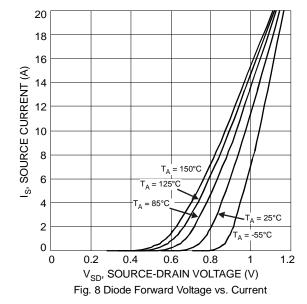
Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

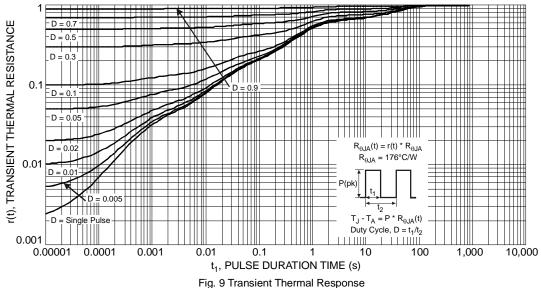


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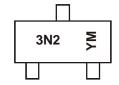


### Ordering Information (Note 5)

Part Number	Case	Packaging
DMN3050S-7	SOT-23	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



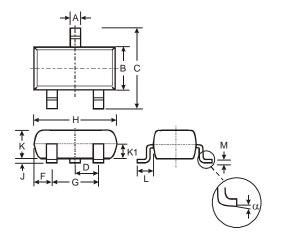
3N2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: V = 2008) M = Month (ex: 9 = September)

Date Code Key

Year	2008		2009	2010		2011	2012		2013	2014		2015
Code	V		W	Х		Υ	Z		Α	В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Au	g Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

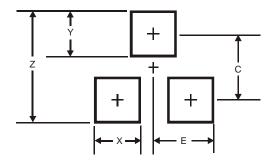


## **Package Outline Dimensions**



SOT-23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.903	1.10	1.00			
K1	-	-	0.400			
L	0.45	0.61	0.55			
M	0.085	0.18	0.11			
α	0°	8°	-			
All	All Dimensions in mm					

## **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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**DMN3050S** 

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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

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